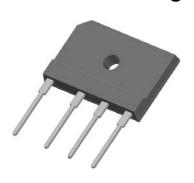
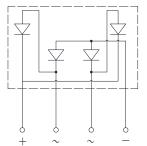




High Efficient Bridge Rectifiers





Features

- UL recognition, file #E230084
- Glass passivated chip junction
- Thin single in-line package
- High surge current capability
- Solder dip 275 °C max. 7 s, per JESD 22-B106

Typical Applications

General purpose use in AC/DC bridge full wave rectification for switching power supply, home appliances, office equipment, industrial automation applications.

Mechanical Data

• Package: 6KBJ

Molding compound meets UL 94 V-0 flammability

rating, RoHS-compliant

• Terminals: Tin plated leads, solderable per

J-STD-002 and JESD22-B102

• Polarity: As marked on body

■Maximum Ratings (Ta=25°C Unless otherwise specified)

■Maximum Ratings (1a-25 € Offiess offierwise specified)					
PARAMETER		SYMBOL	UNIT	HGBJ5006	
Device marking code				HGBJ5006	
Maximum Repetitive Peak Reverse Voltage		VRRM	٧	600	
Maximum RMS Voltage		VRMS	V	420	
Maximum DC blocking Voltage		VDC	٧	600	
Average rectified output current @60Hz sine wave, R-load,	With heatsink T _C =50°C	lo	А	50	
	Without heatsink T _a =25°C			3.5	
Forward Surge Current (Non-repetitive) @60Hz Half-sine wave,1 cycle, Tj=25°C		IFSM	Α	450	
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25°C				900	
Current squared time @1ms≤t≤8.3ms Tj=25°C, Rating of per diode		l²t	A ² s	840.4	
Storage temperature		T _{stg}	°C	-55 ~ +150	
Junction temperature		Tj	°C	-55 ~ + 150	
Dielectric strength @ Terminals to case, AC 1 minute		Vdis	KV	2.5	
Mounting torque @Recommend torque: 5kg·cm		Tor	kg∙cm	8	

HGBJ5006

■Electrical Characteristics (T_a=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	TEST CONDITIONS	HGBJ5006	
Maximum reverse recovery time	t _{rr}	ns	I _F =0.5A,I _R =1.0A, I _n =0.25A	100	
Maximum instantaneous forward voltage drop per diode	VF	>	IFM=25.0A	4	
Maximum DC reverse current at	lR	μА	T _j =25°C	5	
rated DC blocking voltage per dio			T _j =125°C	200	
Typical junction capacitance	Cj	pF	Measured at 1MHz and Applied Reverse Voltage of 4.0 V.D.C		

■Thermal Characteristics (Ta=25°C Unless otherwise specified)

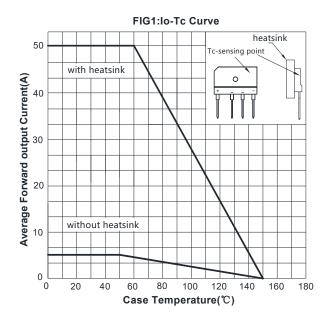
PARAMETER		SYMBOL	UNIT	HGBJ5006
Thermal Resistance	Between junction and ambient, Without heatsink	R ₀ J-A	°C/W	18.0
	Between junction and case, With heatsink	R ₀ J-C		1.0

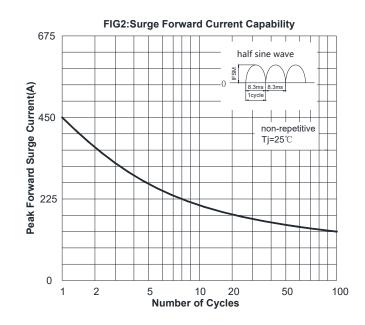
Note: Device mounted on 75mm x 45mm x 5.5mm Aluminum Plate Heatsink.

■Ordering Information (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(g)	MINIIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
HGBJ5006	B1	Approximate 6.5	15	750	1500	TUBE
HGBJ5006	A1	Approximate 6.5	250	250	2000	вох

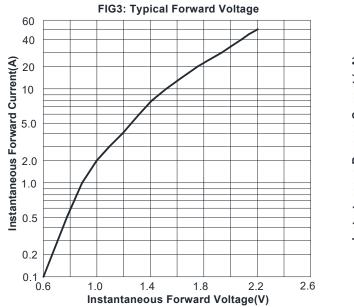
■ Characteristics (Typical)







HGBJ5006



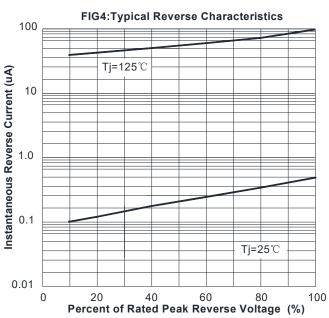
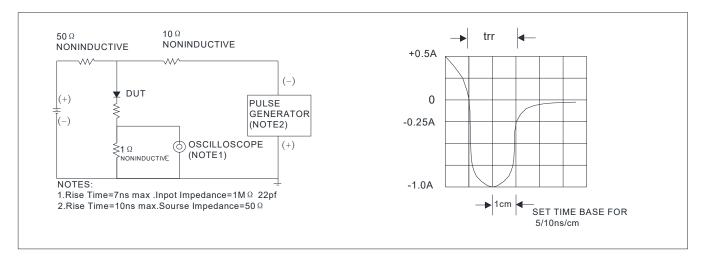


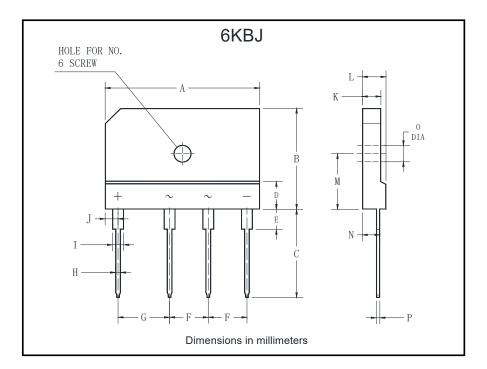
FIG.5: Diagram of circuit and Testing wave form of reverse recovery time







■ Outline Dimensions



6KBJ				
Dim	Min	Max		
Α	29.7	30.3		
В	19.7	20.3		
С	17.0	18.0		
D	4.8	5.8		
Е	3.8	4.2		
F	7.3	7.7		
G	9.8	10.2		
Н	0.9	1.1		
I	2.0	2.4		
J	2.3	2.7		
K	3.4	3.8		
L	4.4	4.8		
М	10.8	11.2		
N	3.1	3.7		
0	3.1	3.4		
Р	0.6	0.8		



HGBJ5006

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